

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT4415010

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ZVI OR-BACH	01/27/2016
BRIAN CRONQUIST	01/29/2016
RECEIVING PARTY DATA	
Name:	Monolithic 3D Inc.
Street Address:	3555 Woodford Drive
City:	San Jose
State/Country:	CALIFORNIA
Postal Code:	95124
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15008444
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	Brian@Monolithic3D.com
Correspondent Name:	BRIAN CRONQUIST
Address Line 1:	3555 WOODFORD DRIVE
Address Line 4:	SAN JOSE, CALIFORNIA 95124
ATTORNEY DOCKET NUMBER:	MONOLITHIC3D-HR7CON3
NAME OF SUBMITTER:	BRIAN CRONQUIST
SIGNATURE:	/bc/
DATE SIGNED:	05/15/2017
Total Attachments: 2	
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source=Monolithic3D-HR7con3-cd_Assignment_Brians#page1.tif	

ASSIGNMENT

Whereas, I, **Zvi Or-Bach** (hereinafter referred to as Assignor(s)), residing in **San Jose, California**; have made a certain invention, and executed United States Patent Application entitled:

Novel Semiconductor Device and Structure

as described in U.S. Patent Application Serial No. 15/008,444 and filed on January 28, 2016;
and

Whereas, **MonolithC 3D™ Inc.**, a company located at 3555 Woodford Drive, San Jose, California 95124 (hereinafter called "Assignee"), desires to acquire the entire right, title, and interest in the application and the invention, and to any applications, patents and/or utility model registrations filed or obtained therefor in every Country (hereinafter called the "Designated Countries").

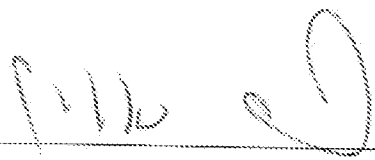
Now therefore, for valuable consideration, receipt of which is hereby acknowledged,

I/we, the above named Assignor(s), hereby sell, assign and transfer to the above named Assignee the entire right, title and interest to file and/or obtain any applications, patents and/or utility model registrations in the Designated Countries as regards the United States application and the invention disclosed therein (including rights of priority based on the United States application), and I/we will execute without further consideration all papers deemed necessary by the Assignee in connection with such applications, patents and/or utility model registrations in the Designated Countries when called upon to do so by the Assignee.

Signed and Sealed:

INVENTOR:

DATE on 1-27-16



 (Zvi Or-Bach)
 First Name Middle Initial Last Name

ASSIGNMENT

Whereas, I, **Brian Cronquist** (hereinafter referred to as Assignor(s)), residing in **San Jose, California**; have made a certain invention, and executed United States Patent Application entitled:

Novel Semiconductor Device and Structure

as described in U.S. Patent Application Serial No. 15/008,444 and filed on January 28, 2016;

and

Whereas, Monolithic 3D™ Inc., a company located at 3555 Woodford Drive, San Jose, California 95124 (hereinafter called "Assignee"), desires to acquire the entire right, title, and interest in the application and the invention, and to any applications, patents and/or utility model registrations filed or obtained therefor in every Country (hereinafter called the "Designated Countries").

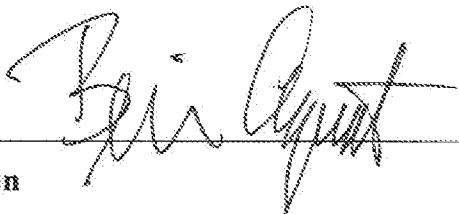
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Signed and Sealed:

INVENTOR:

DATE on 29 Jan 16



 (Brian Cronquist)
 First Name Middle Initial Last Name